



NOTES:

- MATERIAL
HOUSING:THERMOPLASTIC(SEE TABLE),UL94V-0;COLOR:BLACK.
CONTACT: COPPER ALLOY
PAD:STAINLESS STEEL.
- FINISH
CONTACT: 50u" MIN.NICKEL UNDERPLANED AND GOLD PLANTING AT CONTACT AREA
TIN PLATING AT SOLDER AREA
PAD: 50u" MIN. NICKEL UNDERPLANED AND 100u" MIN.Tin PLANTING OVER ALL.
- SPECIFICATION
CONTACT CURRENT RATING:2A.
DIELECTRIC WITHSTANDING VOLTAGE:500VAC FOR 1 MINUTF
INSULATION RESISTANCE:1000MΩ MAX.
CONTACT RESISTANCE:50mΩ MAX.
OPERATING TEMPERATURE:-55°C TO +85°C.
DURABILIRY:5000TIMES
NORMAL FORCE AT WORKING POSITION:60gf Min

TABLE A:

3	SHELL	1	STAINLESS STEEL/PLATED GOLD ON PAD
2	CONTACT	3	COPPER ALLOY/CONTACT AREA GOLD PLATED
1	HOUSING	1	HIGH TEMPERATURE UL 94-V0 BLACK
ITEM	NAME	Q'TY	MATERIAL / FINISH

HADFU ELECTRONCS TECHNOLOGY CO.,LTD

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PART NAME		CONNECTOR		DRAWING		Y,C,ZHANG		DWG.No.		SBICL	
PART NO.		BC3P30H15		CHECK		G.C.Chen		REV.		A1	
UNIT :	TOLERANCE OTHERWISE	UP TO 5	±0.2	ANGLE	APPROVAL	DATE		25-04-2015			
		ABOVE 5~30	±0.3			SCALE		2:1		PAGE	
mm		ABOVE 30	±0.5	0°±3'							